15.4% Culn_{1-X}Ga_XSe₂-Based Photovoltaic Cells from Solution-Based Precursor Films

R.N. Bhattacharya, W. Batchelor, M.A. Contreras, and R.N. Noufi *National Renewable Energy Laboratory*

J.F. Hiltner and J.R. Sites Department of Physics, Colorado State University

Presented at the European Materials Research Society Meeting Strasbourg, France June 1-4, 1999



1617 Cole Boulevard Golden, Colorado 80401-3393

NREL is a U.S. Department of Energy Laboratory Operated by Midwest Research Institute • Battelle • Bechtel

Contract No. DE-AC36-98-GO10337

NOTICE

This report was prepared as an account of work sponsored by an agency of the United States government. Neither the United States government nor any agency thereof, nor any of their employees, makes any warranty, express or implied, or assumes any legal liability or responsibility for the accuracy, completeness, or usefulness of any information, apparatus, product, or process disclosed, or represents that its use would not infringe privately owned rights. Reference herein to any specific commercial product, process, or service by trade name, trademark, manufacturer, or otherwise does not necessarily constitute or imply its endorsement, recommendation, or favoring by the United States government or any agency thereof. The views and opinions of authors expressed herein do not necessarily state or reflect those of the United States government or any agency thereof.

Available to DOE and DOE contractors from: Office of Scientific and Technical Information (OSTI) P.O. Box 62 Oak Ridge, TN 37831 Prices available by calling 423-576-8401

Available to the public from: National Technical Information Service (NTIS) U.S. Department of Commerce 5285 Port Royal Road Springfield, VA 22161 703-605-6000 or 800-553-6847 or DOE Information Bridge http://www.doe.gov/bridge/home.html



Printed on paper containing at least 50% wastepaper, including 20% postconsumer waste

15.4% CuIn_{1-X}Ga_XSe₂-BASED PHOTOVOLTAIC CELLS FROM SOLUTION-BASED PRECURSOR FILMS

R.N. Bhattacharya¹, J. F. Hiltner², W. Batchelor¹, M. A. Contreras¹, R. N. Noufi¹, and J. R. Sites²

¹National Renewable Energy Laboratory, 1617 Cole Blvd., Golden, CO 80401, USA
²Department of Physics, Colorado State University, Fort Collins, CO 80523, USA

Abstract

We have fabricated 15.4%- and 12.4%-efficient $CuIn_{1-X}Ga_XSe_2$ (CIGS)-based photovoltaic devices from solution-based electrodeposition (ED) and electroless-deposition (EL) precursors. Asdeposited precursors are Cu-rich CIGS. Additional In, Ga, and Se are added to the ED and EL precursor films by physical vapor deposition (PVD) to adjust the final film composition to $CuIn_{1-X}Ga_XSe_2$. The ED and EL device parameters are compared with those of a recent world record, an 18.8%-efficient PVD device. The tools used for comparison are current voltage, capacitance voltage, and spectral response characteristics.

Keywords

Electrodeposited, Electroless deposited, CuIn_{1-X}Ga_XSe₂, Physical vapor deposition.

Introduction

Currently, a great deal of effort is being made to develop low-cost technologies for fabricating CIGS thin films.^{1, 2} Several research groups³⁻⁶ have demonstrated high-efficiency CIGS solar cells using physical vapor deposition (PVD) and sputtering techniques. The recent record-breaking 18.8% efficient Cu(In,Ga)Se₂-based device fabricated in our research laboratory is based on a mutistep

process using PVD.³ The PVD method is an excellent tool for understanding film growth and for developing models. The PVD technique is challenging to scale up. Electrodeposition (ED) and electroless-deposition (EL) are potentially suitable preparation methods to obtain the low-cost precursor films. The ED and EL processes could provide: (a) a low-cost, high-rate process; (b) a large-area, continuous, multi-component, low-temperature deposition method; (c) deposition of films on a variety of shapes and forms (wires, tapes, coils, and cylinders); (d) freedom from the requirement or need to use expensive equipment; (e) controlled deposition rates and effective material use; and (f) minimum waste generation (solution can be recycled).

The devices fabricated using ED and EL CIGS precursors resulted in efficiencies of 15.4 % and 12.4%, respectively. The quality of CIGS-based films and devices prepared from the solution-based ED and EL precursor films is very promising. The ED and EL device parameters are compared with those of an 18.8%-efficient PVD device.

Experimental

Codepositions of Cu-In-Ga-Se by the ED and EL processes were performed from a bath containing 0.02–0.05 M CuCl₂, 0.04–0.06 M InCl₃, 0.01–0.03 M H₂SeO₃, 0.08–0.1 M GaCl₃ and 0.7–1 M LiCl dissolved in deionized water. The films were deposited in a vertical cell in which the electrodes (both working and counter) were suspended vertically from the top of the cell. The ED precursors were prepared by using a three-electrode cell in which the reference electrode was Pt (pseudo-reference), the counter electrode was a Pt gauze, and the substrate was Mo/glass. The films were electroplated by applying a constant potential of -1.0 V. A Princeton Applied Research potentiostat/galvanostat Model 273 A with an IBM PC AT computer interface was used for the preparation of ED precursor films. The EL precursor films were prepared using Fe as an oxidizing counter electrode. The Mo film on glass substrate was about 1 μ m thick and was deposited by DC sputtering. The ED and EL deposition experiments were performed at room temperature (24°C) and without stirring. The deposited films were rinsed with deionized water and dried in flowing N₂.

The as-deposited precursors are Cu-rich CIGS films. Additional In, Ga, and Se were added to the precursor films by PVD to adjust the final composition to $\text{CuIn}_{1-x}\text{Ga}_x\text{Se}_2$. The substrate (precursor film) temperature during the PVD step was $560^\circ \pm 10^\circ\text{C}$. The films were also selenized by exposure to selenium vapor during the cool-down time (~40°C/min). At present, addition of In and Ga and also selenization at high temperature are very crucial to obtain high-efficiency devices from ED and El precursor films.

The PVD CIGS absorber is deposited in several stages.⁷ First, $(In_{1-x}Ga_x)_2Se_3$ [In/(In+Ga) = 0.30] is deposited at a substrate temperature of $350 \pm 10^{\circ}C$. In the second stage, Cu-Se is deposited at a substrate temperature of $550^{\circ} \pm 10^{\circ}C$ to form a Cu-rich CIGS layer. In the third stage, the Cu-rich CIGS precursor is converted to photovoltaic-quality material by exposure to $(In_{1-x}Ga_x)_2Se_3$ [In/(In+Ga) = 0.25] at $550^{\circ} \pm 10^{\circ}C$, which enhances the formation of a (In, Ga)-rich surface phase. The final absorber composition is about $0.86 \le Cu/(In+Ga)\epsilon 0.96$.

Photovoltaic devices were completed by chemical-bath deposition of about 50 nm CdS, followed by radio-frequency (RF) sputtering of 50 nm of intrinsic ZnO, and 350 nm of Al₂O₃-doped conducting

ZnO. Bilayer Ni/Al top contacts were deposited in an e-beam system. The final step in the fabrication sequence is the deposition of an antireflection coating (100 nm MgF₂). The final device configuration for all devices is $MgF_2/ZnO/CdS/CuIn_{1-x}Ga_xSe_2/Mo$.

Results and Discussions

The electrodeposition of CIGS films (pH \sim 2) on cathodes is most likely caused by the combination of electrochemical and chemical reactions as follows:

$M^{n+} + ne^{-} \odot M$	(1)
$H_2SeO_3 + 4H^+ + 4e \oslash Se + 3H_2O$	(2)
$xM + ySe \oslash M_xSe_y$	(3)

The electroless process for preparing CIGS precursor films is accomplished by the combination of electrochemical and chemical reactions. The counter-electrode (Fe) initiates the electrochemical reaction. The electroless deposition of CIGS is most likely caused as follows:

E^o vs SHE

$Fe \oslash Fe^{2+} + 2e$	-0.447	(4)
$Cu^+ + e \oslash Cu$	0.521	(5)
$Cu^{2+} + 2e \oslash Cu$	0.342	(6)
$\ln^{3+} + 3e \oslash \ln$	-0.338	(7)
$Ga^{3+} + 3e \oslash Ga$	-0.549	(8)
$\text{SeO}_3^{2^-} + 3\text{H}_2\text{O} + 4\text{e} \ \ \ \text{Se} + 6 \ \text{OH}^-$	-0.366	(9)
Cu, In, Ga, Se \bigcirc Cu _x In _y Ga _z Se _n	Chemical reaction	(10)

The required reduction potential of Ga is higher than the oxidation potential of an Fe electrode. The deposition potential is composed of the equilibrium reduction potentials (E_{eq}), the overpotential, and the ohmic potential drop (iR_s) in the solution. The rest potential of the deposition bath solution is about 0.3 V. The applied potential (E) during codeposition of Cu-In-Ga-Se using Fe electrode is (0.447 + rest potential), which probably make the Ga deposition possible.

The composition of the as-deposited ED and EL precursors precursor as analyzed by inductively coupled plasma analysis (ICP) was $CuIn_{0.32}Ga_{0.01}Se_{0.93}$ and $CuIn_{0.35}Ga_{0.01}Se_{0.99}$, respectively. The thickness of the ED and EL precursor films was about 2.2 and 1.5 µm, respectively. The composition of the ED precursor film was adjusted by adding about 3000 Å Ga and 7200 Å In by PVD step. The composition of the EL precursor film was adjusted by adding about 2500 Å Ga and 5800 Å In by PVD step. The final compositions of the CIGS absorber films prepared from ED and

EL precursors, as determined by ICP and electron-probe microanalysis, are $CuIn_{0.72}Ga_{0.47}Se_{2.05}$ and $CuIn_{0.83}Ga_{0.22}Se_{1.93}$, respectively.

The Ga/(In+Ga) ratios, as determined by inductively coupled plasma and electron-probe microanalysis, are 0.40, 0.20, and 0.28 for the ED, EL, and PVD cells that will be compared, resulting in band gaps, E_g , of 1.20 eV, 1.09 eV, and 1.12 eV, respectively. Figure 1a shows the current density-vs.-voltage (J-V) curves of the devices. The device prepared from ED precursor film seems to compare well with the 18.8%-efficient PVD device in open-circuit voltage (V_{oc}), and less well in short-circuit current (J_{sc}), however, because of the band gap energy difference of 80 mV, one would expect a higher voltage in the ED device if all other qualities of the junction were equal. Quantum efficiency (QE) results are shown in Figure 1b. The ED cell shows comparable collection with the PVD device in the 500–1000-nm range, while the EL cell shows less collection in the same range for its band gap. This indicates an improvement in the carrier diffusion length in the ED cell in comparison with the EL cell. The different QE cutoffs in the red indicate the different band gaps, which are assumed to be due to variations in Ga content. The capacitance-voltage (C-V) results, Figure 1c, show a fairly uniform dopant density of 10¹⁶ cm⁻³ for the ED cell and 1.5x10¹⁶ cm⁻³ for the EL cell. These are both within the typical range for high-quality CIGS cells.

Cell	ED device	El device	PVD device
Ga/(In+Ga)	0.4	0.20	0.28
Area [cm ²]	0.418	0.418	0.432
V _{oc} [V]	0.666	0.565	0.678
$J_{sc} [mA/cm^2]$	30.51	33.27	35.2
V _{max} [V]	0.554	0.434	0.567
$J_{max} [mA/cm^2]$	27.8	28.6	34.5
FF [%]	75.6	66.1	78.6
$r_{\rm shunt} [\Omega-\rm{cm}^2]$	2000	1000	10000
R_{series} [Ω -cm ²]	0.3	0.1	0.2
Ideality Factor [A]	1.8	2.5	1.5
Depletion Width [µm]	0.2	0.25	0.5
Hole Density [cm ⁻³]	1×10^{16}	1.5×10^{16}	1×10^{16}
Band Gap [eV]	1.20	1.09	1.12
Efficiency [%]	154	12.4	18.8

Table 1. Parameters of the Devices Prepared from Electrodeposition Precursor (EDdevice), Electroless-Deposition Precursor (EL device) and also from Physical VaporDeposition (PVD device)

Electrical characterization data of the devices prepared from ED precursors are listed in Table 1. Electrical characterization of the devices included current-voltage in the dark and under AM 1.5, 100-mW/cm^2 illuminated conditions, QE, and C-V measurements. Resistance and diode-quality parameters were extracted from the J-V data. The shunt resistance (r_{shunt}) is a measure of leakage

and is indicated by the slope of the J-V curve in reverse bias. The devices prepared from ED and EL precursors demonstrate slight leakage in the light, with shunt resistances of 1000-2000 ohm-cm², as compared to the PVD device, with a higher value of 10000 ohm-cm². Series resistance (R_{series}) is indicative of the quality of the bulk material, whereas the diode-quality factor (A) indicates whether there is significant excess forward current through recombination states and hopping paths. Both of these quantities are extracted from the region of the curve between the maximum power point and open-circuit voltage.⁸ As with shunting, the series resistance is not a significant factor for any of the cells. The quality factor of the EL device, however, is much greater than the other two. This is illustrated in Figure 1d, showing logarithmic forward-current comparisons with resistive losses removed. The more shallow slope for the EL device corresponds to a higher quality factor. The more ideal quality factor for the ED device, along with its higher V_{oc} and improved diffusion length, indicates that the ED process yields an improved material quality compared with the EL process.

	ED vs. PVD (adjusted for E_g)	EL vs. PVD (adjusted for E_g)
Efficiency Difference [%]	3.4 (3.4)	6.4 (6.4)
Difference from V _{oc} [%]	0.3 (1.4)	2.5 (2.1)
Difference from J _{sc} [%]	2.3 (1.2)	0.8 (1.2)
Difference from FF [%]	0.8 (0.8)	3.1 (3.1)

Table 2. Comparison of Primary ED and EL Parameters with the Record 18.8%-Efficient PVD Cell

Table 2 shows the relative contributions of the primary solar-cell parameters to the lower performance seen the in ED and EL cells. The differences in voltage and current can be misleading if cells of different band gap are compared, and hence the second values in parenthesis, which are the performance differences for a common band gap. The second values show, in comparison with the PVD device, (a) somewhat smaller voltages attributed to the excess forward current, with a larger difference for the EL cells, (b) somewhat smaller currents primarily due to lower collection of carriers created by the more penetrating infrared photons, and (c) a small fill-factor (FF) difference for the EL cell, due to the increased diode quality factor.

Conclusion

The ED and EL processes are simple and fast, and they can synthesize binary or multinary precursors for subsequent processing into high-quality CIGS thin-film absorbers for solar cells. The device fabricated using ED precursor layers resulted in efficiencies as high as 15.4%, and none of the individual parameters showed significant deterioration from those of the PVD CIGS cells. The quality of CIGS-based films and devices prepared from ED precursors is very promising. This may lead to novel, fast, and low-cost methods for solar-cell absorber fabrication.



Acknowledgements

This work was supported by Davis, Joseph & Negley (California Corporation, Work-for-Others Contract No. 1326) and also by the U.S. Department of Energy under contract DE-AC36-98-G010337.

References

[1] R. N. Bhattacharya, H. Wiesner, T. A. Berns, R. J. Matson, J. Keane, K. Ramanathan, A. Swartzlander, A. Mason, and R. N. Noufi, *J. Electrochem. Soc.* 144 (1997) 1376.

[2] K. Kushiya, M. Tachiyuki, T. Kase, I. Sugiyama, Y. Nagoya, D. Okumura, M. Satoh, I. Sugiyama, O. Yamase, H. Takeshita, *Solar Energy Materials and Solar Cells* 49 (1997) 277.

[3] M. A. Contreras, B. Egaas, K. Ramanathan, J. Hiltner, A. Swartzlander, F. Hasoon, and R. Noufi, *Progress in Photovoltaics*, in press.

[4] L. Stolt, J. Heldstrom, J. Kessler, M. Ruckh, K.O. Velthaus, and H. W. Schock, *Appl. Phys. Lett.* 62 (1993) 597.

[5] N. Kohara, T. Negami, M. Nishitani, and T. Wada, Jpn. J. Appl. Phys. 34 (1995) L1141.

[6] J.R. Tuttle, M.A. Contreras, K.R. Ramanathan, S.E. Asher, R.N. Bhattacharya, T.A. Berens, J. Keane, and R. Noufi, *American Institute of Physics Conference Proceedings* 394 (1996) 83.

[7] M. A. Contreras, J. R. Tuttle, A. Gabor, A. Tennant, K. Ramanathan, S. Asher, A. Franz, J. Keane, L. Wang, J. Scofield, and R. Noufi, *First WCPEC Conference*, Dec. 5-9, Hawaii, 1994, 68.

[8] J.R. Sites and P.H. Mauk, Solar Cells, 27 (1989) 411.

REPORT DOCUMENTATION PAGE		Form Approved OMB NO. 0704-0188	
Public reporting burden for this collection of information is estimated to average 1 hour per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the collection of information. Send comments regarding this burden estimate or any other aspect of this collection of information, including suggestions for reducing this burden, to Washington Headquarters Services, Directorate for Information operations and Reports, 1215 Jefferson Davis Highway, Suite 1204, Arlington, VA 22202-4302, and to the Office of Management and Budget, Paperwork Reduction Project (0704-0188), Washington, DC 20503.			
1. AGENCY USE ONLY (Leave blank)	2. REPORT DATE May 1999	3. REPORT TYPE AND DATES COVERED Conference Paper	
 4. TITLE AND SUBTITLE 15.4% CuIn_{1-x}Ga_xSe₂-Based Photovoltaic Cells from Solution-Based Precursor Films 6. AUTHOR(S) 		5. FUNDING NUMBERS C: TA: PV904301	
 Bhattacharya, K.N., Hiltner, J.F., Batchelor, W., Contreras, M.A., Noufi, K.N., and Sites, J.R. 7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) National Renewable Energy Laboratory 1617 Cole Blvd. Golden, CO 80401-3393 		8. PERFORMING ORGANIZATION REPORT NUMBER	
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES)		10. SPONSORING/MONITORING AGENCY REPORT NUMBER	
		CP-520-26611	
11. SUPPLEMENTARY NOTES			
12a. DISTRIBUTION/AVAILABILITY STAT National Technical Informatio U.S. Department of Commerce 5285 Port Royal Road Springfield, VA 22161	EMENT on Service ce		12b. DISTRIBUTION CODE
13. ABSTRACT (Maximum 200 words) We have fabricated 15.4%- and 12.4%-efficient CuIn _{1-X} Ga _X Se ₂ (CIGS)-based photovoltaic devices from solution-based electrodeposition (ED) and electroless-deposition (EL) precursors. As-deposited precursors are Cu-rich CIGS. Additional In, Ga, and Se are added to the ED and EL precursor films by physical vapor deposition (PVD) to adjust the final film composition to CuIn _{1-X} Ga _X Se ₂ . The ED and EL device parameters are compared with those of a recent world record, an 18.8%-efficient PVD device. The tools used for comparison are current voltage, capacitance voltage, and spectral response characteristics.			
14. SUBJECT TERMS		15. NUMBER OF PAGES	
photovoltaics ; electrodeposited ; electroless deposited ; $CuIn_{1-x}Ga_xSe_2$; physical vapor deposition			
17. SECURITY CLASSIFICATION OF REPORT Unclassified	18. SECURITY CLASSIFICATION OF THIS PAGE Unclassified	19. SECURITY CLASSIFICATION OF ABSTRACT Unclassified	16. PRICE CODE

NSN 7540-01-280-5500

Standard Form 298 (Rev. 2-89) Prescribed by ANSI Std. 239-18 298-102